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April 1st, 2010 Renesas Electronics Corporation

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MOS FIELD EFFECT TRANSISTOR



μ PA2720GR

SWITCHING N-CHANNEL POWER MOSFET

DESCRIPTION

The µPA2720GR is N-channel MOS Field Effect Transistor designed for power management applications of notebook computers and Li-ion battery protection circuit.

FEATURES

• Low on-state resistance

 $R_{DS(on)1} = 6.6 \text{ m}\Omega \text{ MAX}. \text{ (Vgs} = 10 \text{ V, I}_D = 7 \text{ A)}$

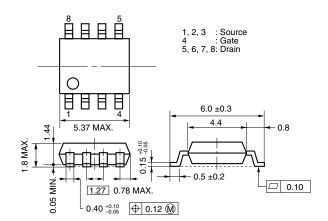
 $R_{DS(on)2} = 10 \text{ m}\Omega \text{ MAX.} (V_{GS} = 4.5 \text{ V}, I_{D} = 7 \text{ A})$

- Low Ciss: Ciss = 2800 pF TYP. (VDS = 10 V, VGS = 0 V)
- Built-in gate protection diode
- Small and surface mount package (Power SOP8)

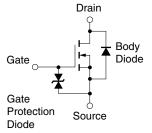
ORDERING INFORMATION

PART NUMBER	PACKAGE
μ PA2720GR-E1	Power SOP8
μPA2720GR-E1-A ^{Note}	Power SOP8
μ PA2720GR-E2	Power SOP8
μ PA2720GR-E2-A ^{Note}	Power SOP8

PACKAGE DRAWING (Unit: mm)



EQUIVALENT CIRCUIT



Note Pb-free (This product does not contain Pb in external electrode and other parts.)

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (VGS = 0 V)	VDSS	30	V
Gate to Source Voltage (VDS = 0 V)	Vgss	V	
Drain Current (DC)	ID(DC)	±14	Α
Drain Current (pulse) Note1	ID(pulse)	±140	Α
Total Power Dissipation Note2	P _{T1}	1.1	W
Total Power Dissipation (PW = 10 sec) Note2	P _{T2}	2.5	W
Channel Temperature	Tch	150	°C
Storage Temperature	Tstg	-55 to +150	°C

Notes 1. PW \leq 10 μ s, Duty Cycle \leq 1%

2. Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm

Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

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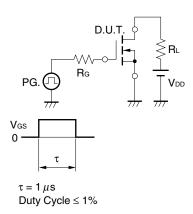


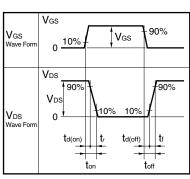
ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V			1	μA
Gate Leakage Current	Igss	V _{GS} = ±20 V, V _{DS} = 0 V			±10	μΑ
Gate Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.0		2.5	V
Forward Transfer Admittance Note	yfs	V _{DS} = 10 V, I _D = 7 A	8			S
Drain to Source On-state Resistance Note	RDS(on)1	V _{GS} = 10 V, I _D = 7 A		5.2	6.6	mΩ
	RDS(on)2	V _{GS} = 4.5 V, I _D = 7 A		7.0	10	mΩ
Input Capacitance	Ciss	V _{DS} = 10 V		2800		pF
Output Capacitance	Coss	V _{GS} = 0 V		540		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		360		pF
Turn-on Delay Time	t _{d(on)}	V _{DD} = 15 V, I _D = 7 A		16		ns
Rise Time	tr	V _{GS} = 10 V		25		ns
Turn-off Delay Time	t _{d(off)}	R _G = 10 Ω		70		ns
Fall Time	t _f			26		ns
Total Gate Charge	Q G	V _{DD} = 15 V		27		nC
Gate to Source Charge	Qgs	V _{GS} = 5 V		7		nC
Gate to Drain Charge	Q _{GD}	I _D = 14 A		12		nC
Body Diode Forward Voltage Note	V _{F(S-D)}	I _F = 14 A, V _{GS} = 0 V		0.8		V
Reverse Recovery Time	trr	I _F = 14 A, V _{GS} = 0 V		34		ns
Reverse Recovery Charge	Qrr	di/dt = 50 A/μs		27		nC

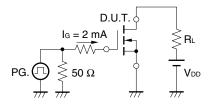
Note Pulsed

TEST CIRCUIT 1 SWITCHING TIME



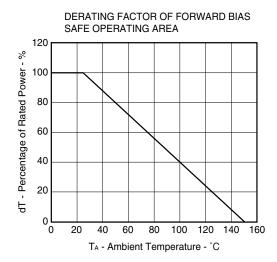


TEST CIRCUIT 2 GATE CHARGE





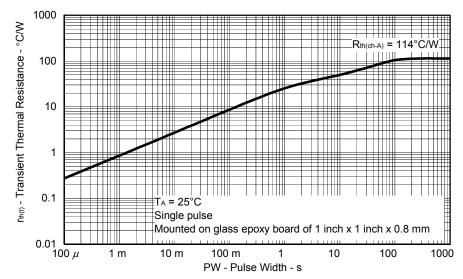
TYPICAL CHARACTERISTICS (TA = 25°C)



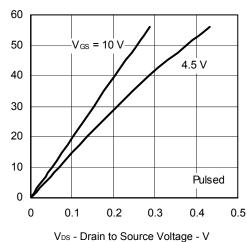
TA = 25°C O.1 Single pulse Mounted on glass epoxy board of 1 inch x 1 inch x 0.8 mm O.01 O.0

VDS - Drain to Source Voltage - V

TRANSIENT THERMAL RESISTANCE vs. PULSE WIDTH

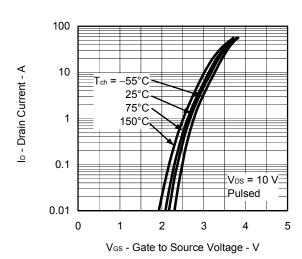




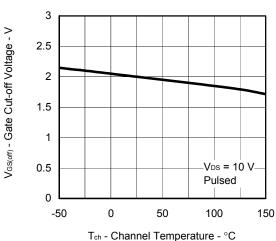


lo - Drain Current - A

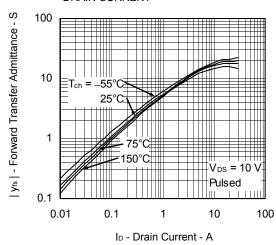
FORWARD TRANSFER CHARACTERISTICS



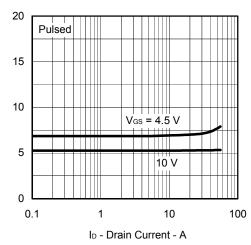
GATE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



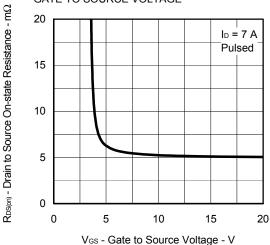
FORWARD TRANSFER ADMITTANCE vs. DRAIN CURRENT



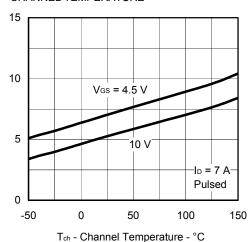
DRAIN TO SOURCE ON-STATE RESISTANCE vs. DRAIN CURRENT



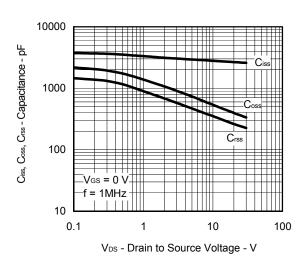
DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE



DRAIN TO SOURCE ON-STATE RESISTANCE vs. CHANNEL TEMPERATURE



CAPACITANCE vs. DRAIN TO SOURCE VOLTAGE

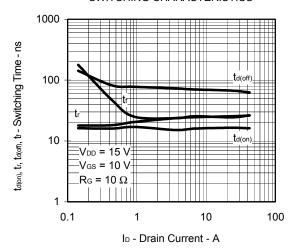


RDS(on) - Drain to Source On-state Resistance - m\Omega

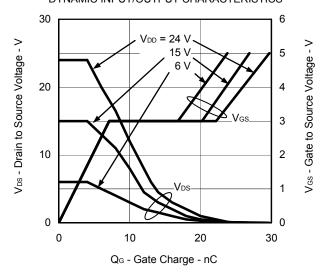
R_{DS(o1)} - Drain to Source On-state Resistance - mΩ



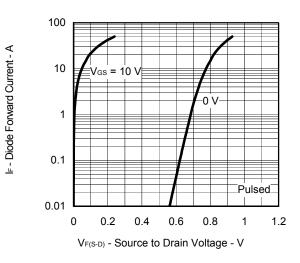
SWITCHING CHARACTERISTICS



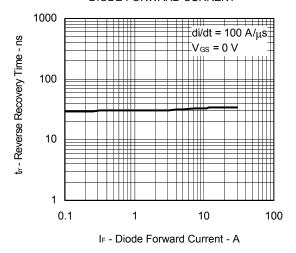
DYNAMIC INPUT/OUTPUT CHARACTERISTICS



SOURCE TO DRAIN DIODE FORWARD VOLTAGE



REVERSE RECOVERY TIME vs. DIODE FORWARD CURRENT





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